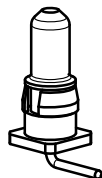


M 2:1



Masse nur informativ,
keine Prüfpläne erstellen.

Technical Data:

Insertion/withdrawal force per contact:	≤ 10N / ≤ 1,6N
Mechanical operations:	≥ 500
Contact resistance:	≤ 1 mOhm
Operation Temperature:	-55°C - +125°C
Solder temperature:	according JEDEC 020C
Suitable assembly process:	leadfree wave / reflow soldering
RoHS compliance:	yes (6/6)
Designed for use with:	angled male DIN connector (M-style)
Packaging:	antistatic plastic bag
Packaging unit:	100 pieces per bag
Marking of packaging:	label or direct printed on bag required date see ERNI labeling spec. 254792
Current capacity:	10A / 70°C

Missing informations
and dimensions
see at DIN 41626

594170	1	2-4µm NiP+ 0,1µm Au	2-4µm NiP+ 0,1µm Au+ 2-3 µm Sn
594171	2	2-3µm Ni min. 0,8µm Au sel.	2-3µm Ni, 2-3µm Sn, alternative to Sn Au-surface also possible
284817	1	2-3µm Ni min. 1,3µm Au sel.	
Part-No.	Class	Plating Mating Area	Plating Termination Area

Information:		Tolerances	Scale 5:1		
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			Subject to modification without prior notice. Drawing will not be updated.		
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t	18.06.2015	Class		STVSKO	
Index	Date				

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